

4V Drive Nch+Pch MOSFET

SH8M3

●Structure

Silicon N-channel / P-channel MOSFET

●Features

- 1) Low on-resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small Surface Mount Package (SOP8).

●Application

Power switching, DC / DC converter.

●Packaging specifications

Type	Package	Taping
	Code	TB
	Basic ordering unit (pieces)	2500
SH8M3		○

●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits		Unit
		Nchannel	Pchannel	
Drain-source voltage	V_{DSS}	30	-30	V
Gate-source voltage	V_{GSS}	±20	±20	V
Drain current	Continuous	I_D	±5.0	A
	Pulsed	I_{DP}^{*1}	±20	A
Source current (Body diode)	Continuous	I_S	1.6	A
	Pulsed	I_{SP}^{*1}	20	A
Total power dissipation	P_D^{*2}	2		W
Channel temperature	T_{ch}	150		°C
Storage temperature	T_{stg}	-55 to +150		°C

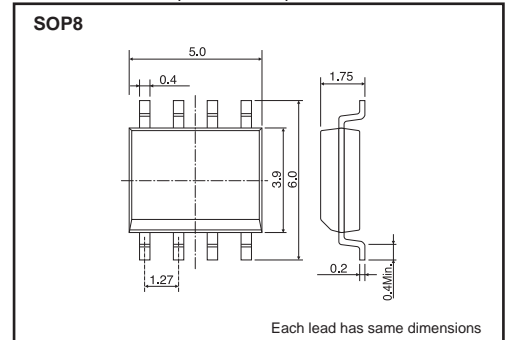
*1 $P_W \leq 10\mu s$, Duty cycle $\leq 1\%$
*2 MOUNTED ON A CERAMIC BOARD.

●Thermal resistance

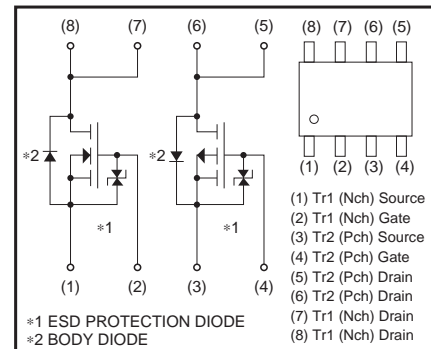
Parameter	Symbol	Limits	Unit
Channel to ambient	$R_{th(ch-a)}^*$	62.5	°C / W

*MOUNTED ON A CERAMIC BOARD.

●Dimensions (Unit : mm)



●Inner circuit



*1 ESD PROTECTION DIODE
*2 BODY DIODE
*A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use the protection circuit when the fixed voltages are exceeded.

N-ch

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I _{GSS}	–	–	±10	μA	V _{GS} =±20V, V _{DS} =0V
Drain-source breakdown voltage	V _{(BR)DSS}	30	–	–	V	I _D =1mA, V _{GS} =0V
Zero gate voltage drain current	I _{DSS}	–	–	1	μA	V _{DS} =30V, V _{GS} =0V
Gate threshold voltage	V _{GS(th)}	1.0	–	2.5	V	V _{DS} =10V, I _D =1mA
Static drain-source on-state resistance	R _{DS(on)} *	–	36	51	mΩ	I _D =5.0A, V _{GS} =10V
		–	52	73		I _D =5.0A, V _{GS} =4.5V
		–	58	82		I _D =5.0A, V _{GS} =4V
Forward transfer admittance	Y _{fs} *	3.0	–	–	S	I _D =5.0A, V _{DS} =10V
Input capacitance	C _{iss}	–	230	–	pF	V _{DS} =10V
Output capacitance	C _{oss}	–	80	–	pF	V _{GS} =0V
Reverse transfer capacitance	C _{rss}	–	50	–	pF	f=1MHz
Turn-on delay time	t _{d(on)} *	–	6	–	ns	I _D =2.5A, V _{DD} ≐15V
Rise time	t _r *	–	8	–	ns	V _{GS} =10V
Turn-off delay time	t _{d(off)} *	–	22	–	ns	R _L =6.0Ω
Fall time	t _f *	–	5	–	ns	R _G =10Ω
Total gate charge	Q _g *	–	3.9	–	nC	V _{DD} ≐15V
Gate-source charge	Q _{gs} *	–	1.1	–	nC	V _{GS} =5V
Gate-drain charge	Q _{gd} *	–	1.4	–	nC	I _D =5.0A

*Pulsed

●Body diode characteristics (Source-Drain) (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V _{SD} *	–	–	1.2	V	I _S =6.4A, V _{GS} =0V

*Pulsed

P-ch

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I_{GSS}	-	-	± 10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	-30	-	-	V	$I_D = -1mA, V_{GS} = 0V$
Zero gate voltage drain current	I_{DSS}	-	-	-1	μA	$V_{DS} = -30V, V_{GS} = 0V$
Gate threshold voltage	$V_{GS(th)}$	-1.0	-	-2.5	V	$V_{DS} = -10V, I_D = -1mA$
Static drain-source on-state resistance	$R_{DS(on)}$ *	-	40	56	m Ω	$I_D = -4.5A, V_{GS} = -10V$
		-	57	80		$I_D = -2.5A, V_{GS} = -4.5V$
		-	65	90		$I_D = -2.5A, V_{GS} = -4.0V$
Forward transfer admittance	$ Y_{fs} $ *	3.5	-	-	S	$I_D = -2.5A, V_{DS} = -10V$
Input capacitance	C_{iss}	-	850	-	pF	$V_{DS} = -10V$
Output capacitance	C_{oss}	-	190	-	pF	$V_{GS} = 0V$
Reverse transfer capacitance	C_{rss}	-	120	-	pF	$f = 1MHz$
Turn-on delay time	$t_{d(on)}$ *	-	10	-	ns	$I_D = -2.5A, V_{DD} = -15V$
Rise time	t_r *	-	25	-	ns	$V_{GS} = -10V$
Turn-off delay time	$t_{d(off)}$ *	-	60	-	ns	$R_L = 6.0\Omega$
Fall time	t_f *	-	25	-	ns	$R_G = 10\Omega$
Total gate charge	Q_g *	-	8.5	-	nC	$V_{DD} = -15V$
Gate-source charge	Q_{gs} *	-	2.5	-	nC	$V_{GS} = -5V$
Gate-drain charge	Q_{gd} *	-	3.0	-	nC	$I_D = -4.5A$

*Pulsed

●Body diode characteristics (Source-Drain) (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V_{SD}	-	-	-1.2	V	$I_S = -1.6A, V_{GS} = 0V$

N-ch

●Electrical characteristic curves

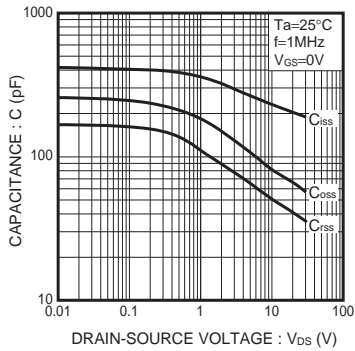


Fig.1 Typical Capacitance vs. Drain-Source Voltage

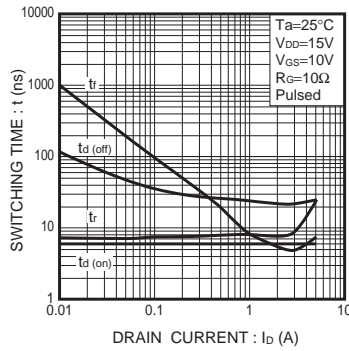


Fig.2 Switching Characteristics

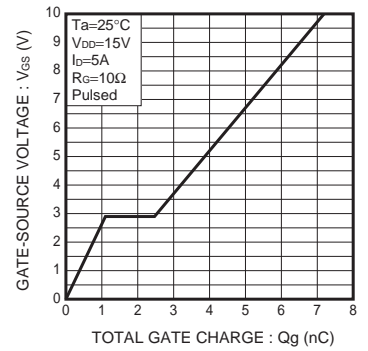


Fig.3 Dynamic Input Characteristics

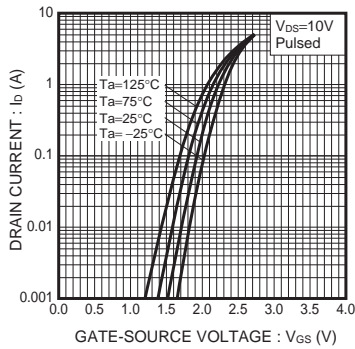


Fig.4 Typical Transfer Characteristics

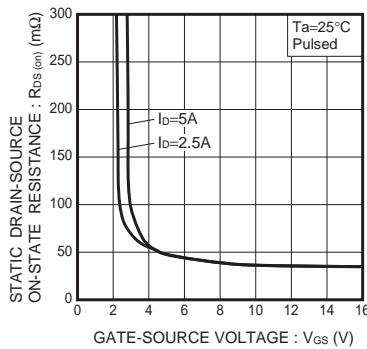


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

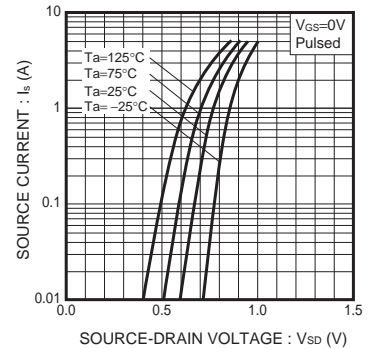


Fig.6 Source Current vs. Source-Drain Voltage

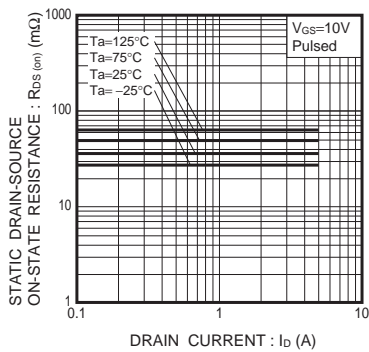


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (I)

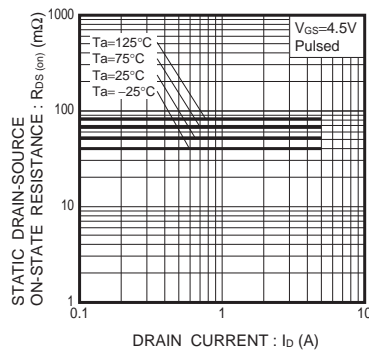


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current (II)

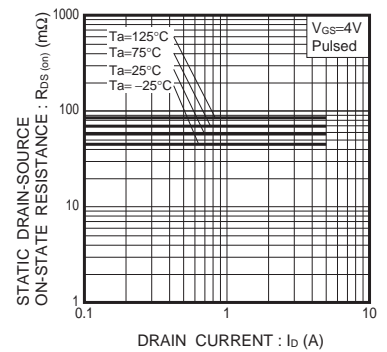


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current (III)

P-ch

●Electrical characteristic curves

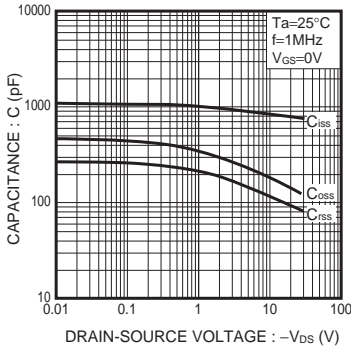


Fig.1 Typical Capacitance vs. Drain-Source Voltage

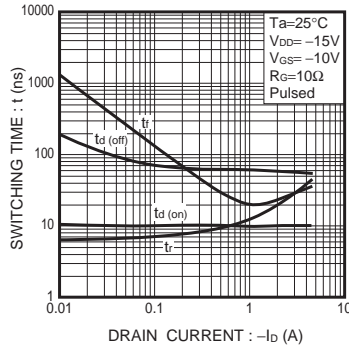


Fig.2 Switching Characteristics

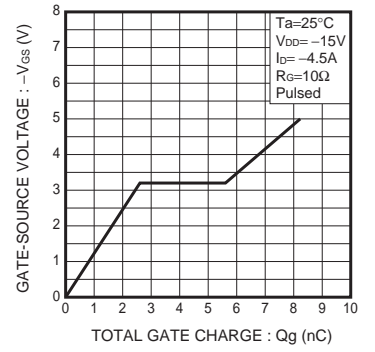


Fig.3 Dynamic Input Characteristics

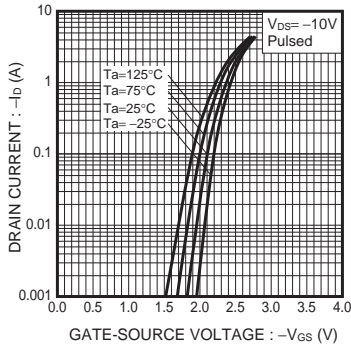


Fig.4 Typical Transfer Characteristics

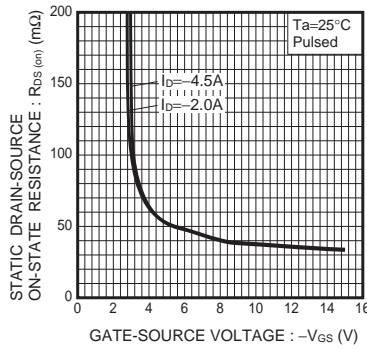


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

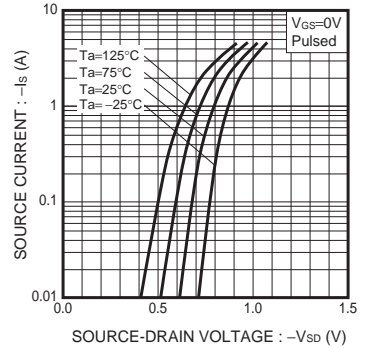


Fig.6 Source Current vs. Source-Drain Voltage

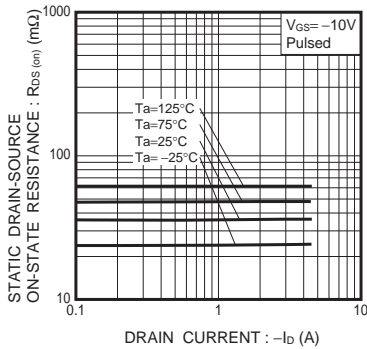


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (I)

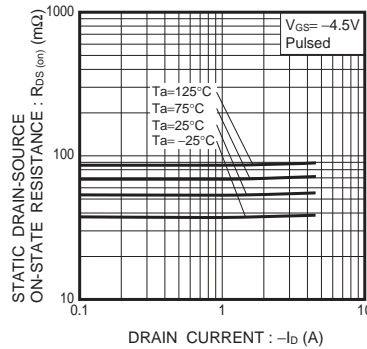


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current (II)

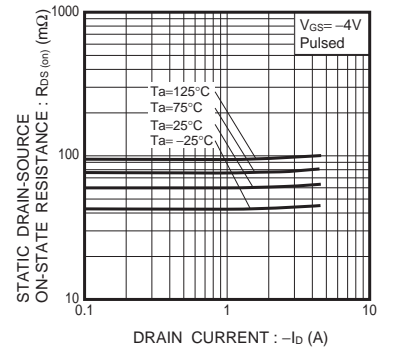


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current (III)

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